

PLASMA BASED STRUCTURED ILLUMINATION MICROSCOPY

*

1 Abstract

We present a linear high-resolution imaging scheme based on the plasma waves originating in the channel of field-effect transistors. The extremely small plasmonic wavelength along with a tunable illumination pattern in the far infrared region can resolve nano-scale objects over a broad range of frequencies.

2 Introduction

The resolution of a conventional fluorescent microscope is governed by the Abbe diffraction limit, restricting it to half the wavelength of the source used for illumination [1]. There are techniques that yield resolution beyond the diffraction limit, among them the most common is confocal microscopy, which uses pinholes to generate a focused point illumination and subsequently a high resolution image of the fluorescent sample. Despite improved resolution, the pinhole discards a portion of the emitted light due to which the signal level may become unusably low, particularly for weakly fluorescent biological samples. Moreover, because the point source illuminates only a small portion of the sample, it must be mechanically moved in order to scan the whole sample, therefore resulting in a slow imaging process. Structured Illumination microscopy (SIM) is a fast

*Last Modified: 12:37, Wednesday 12th April, 2017.

and wide-field microscopic technique in which the sample is illuminated by a non-uniform, modulated and spatially structured pattern revealing the high resolution information of a sample in the form of Moiré fringes [2, 3]. In order to yield a high resolution result, post-processing of a series of such images is performed to extract the high frequency content. A two-fold resolution enhancement is possible using linear SIM techniques. On the other hand, theoretically unlimited resolution enhancement can be obtained using non-linear techniques [4]. However, such methods require very high intensities to illuminate the sample, increasing the likelihood of damage particularly in biological applications.

The idea of illuminating the sample with surface waves having wavelength much smaller than free-space wavelength at the same frequency was first proposed in [5] resulting in super-resolution. Surface plasmons existing at a metal-dielectric interface were used to excite a sample at optical frequencies in [6]. Similarly, in the mid-infrared frequency region, using graphene plasmons was proposed to achieve resolution two orders of magnitude beyond the diffraction limit [7].

Two-dimensional electron gas (2DEG) is a tightly confined sheet of free electrons formed at the interface of semiconductor hetero-junctions in transistor-like structures. By virtue of the high electron concentration and unusually high mobility, the 2DEG exhibits extraordinary electromagnetic properties and physical phenomena [8, 9, 10]. Plasma waves originating in the two-dimensional electron channel of field-effect transistors, discovered more than 30 years ago have lately received interest because of the potential to realize terahertz frequency sources and sensors [11, 12, 13, 14, 15]. For micron order lengths, the channel becomes a plasma cavity where the resonant frequency lies in the far-infrared (terahertz) frequency region and remarkably, can be tuned by varying the gate voltage. The gate bias also controls the electron velocity in the channel ranging from $.1 - 10 \times 10^6 m/s$ [16]. The 2DEG mobility below liquid nitrogen temperature (77 K) is very high $\approx 10^4 cm^2 V^{-1} s^{-1}$ [15], resulting in undamped and low loss oscillations in the channel. It must be mentioned that substantial loss is introduced at room temperature because the mobility drops by at least two orders than the one listed above.

In this paper, we propose an extended structured illumination microscopy using plasma waves as the illumination source. The resolution enhancement is proportional to the wavenumber, which in our case can reach up to 100.

3 Generating Illumination pattern

We consider a Gallium Nitride / Aluminum Gallium Arsenide (GaN/AlGaAs) heterostructure with material properties derived from [15] as shown in Fig. 3. The GaN substrate is highly doped from the bottom to construct the gate terminal while the thickness d of AlGaAs barrier layer is 20nm. The 2DEG region can be described in terms of a surface conductivity given by:

$$\sigma_s(\omega) = \frac{N_s e^2 \tau_p}{m^*} \frac{1}{1 + j\omega\tau} \quad (1)$$

where N_s is surface charge density, e is electron charge, m^* is the effective mass of the 2D electrons and τ is the electron scattering time in the channel related to mobility μ by $\tau = \mu m^* / e$. The material properties are listed in 1. Ignoring scattering effects and assuming the 2DEG is located between two dielectric halfspaces, the dispersion relation for a TM_x excited plane wave is expressed as [17]:

$$\frac{\epsilon_1}{k_{z1}} + \frac{\epsilon_2}{k_{z2}} = -\frac{\sigma_s(\omega)}{\omega} \quad (2)$$

where ϵ_1 and ϵ_2 are the dielectric constants of the barrier and substrate layers respectively and $k_{zi} = \sqrt{k_0^2 \epsilon_i(\omega) - k_x^2}$ is the transverse propagation constant with k_0 being the free-space propagation constant. In the non-retarded regime ($k_x \gg k_0$), the solution for the lateral wavenumber k_x from (2) can be approximated as [18]:

$$k_x \approx \omega \frac{\epsilon_1 + \epsilon_2}{\sigma_s(\omega)} \quad (3)$$

4 Imaging Technique

The SIM technique can be split into two operations; one at the sample end and the other on the microscope end. First, the sample is illuminated with a non-uniform, modulated pattern of sinusoidal shape. Only the portion of the sample that falls under the peak of the illumination signal is focused while the rest of the sample remains unfocused. Other portions are focused by laterally shifting the illumination pattern. Through *optical sectioning* of the sample, a number of acquired are combined to generate a focused 1. It creates optical sectioning that is excite different lateral portions of the sample by shifting of the pattern. The portion of the sample that is illuminated by the peak of the pattern is excited and it fluoresces while the rest of the sample is illuminated homogeneously by a uniform pattern. When the pattern is shifted, other portions of the sample are illuminated. This way the whole sample can be sequentially illuminated with high localized

focused areas.

2. The other part of SIM deals with generation of Moiré effect that actually results in high resolution. The effect is created when the illumination signal is modulated by the sample signal. The objective lens of a microscope can be considered as a low-pass filter due to diffraction. The impulse response of the filter, i.e., the image of a point source, is a blurred spot termed as the *point spread function*(PSF) of the microscope. When a sample that can be represented by $f(x,y)$ is illuminated by a signal $i(x,y)$, the output image, $m(x,y)$ of the microscope can be written in the spatial domain as [19]: In terms of filter theory, the objective lens of a microscope can be considered as a diffraction limited low-pass filter that has a passband spanning up to $2k_0$ under ideal circumstances where k_0 is the free-space wavenumber. The impulse response of the filter, i.e., the image of a point source, is a blurred spot termed as the *point spread function*(PSF) of the microscope. When a sample that can be represented by $f(x,y)$ is illuminated by a signal $i(x,y)$, the output image, $m(x,y)$ of the microscope can be written in the spatial domain as [19]:

where τ_p is the momentum relaxation time and m^* is the effective mass of electrons. When the

Table 1: Material properties of GaN/AlGaN heterostructure [15]

N_s	$7.5 \times 10^{12} \text{cm}^{-2}$
ϵ_1	9.5
ϵ_2	9.6
d	20nm
L	2nm
m^*	$.2m_e$
τ_{77K}	$1.14 \times 10^{-12} \text{s}$
μ_{77K}	$10^4 \text{cm}^2 \text{V}^{-1} \text{s}^{-1}$
τ_{295K}	$.14 \times 10^{-12} \text{s}$
μ_{295K}	$1200 \text{cm}^2 \text{V}^{-1} \text{s}^{-1}$

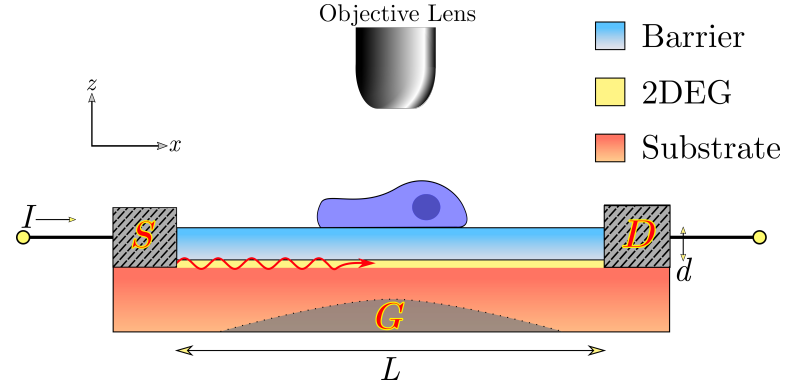


Figure 1: Schematic of the structure. 2DEG exists between a barrier layer of thickness d and substrate

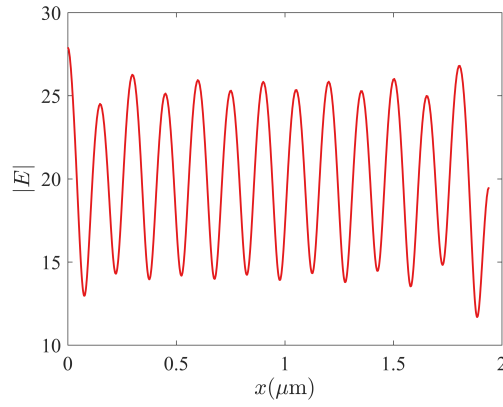


Figure 2: Absolute value of electric field along the $2\mu\text{m}$ long channel GaAs/AlGaAs heterostructure

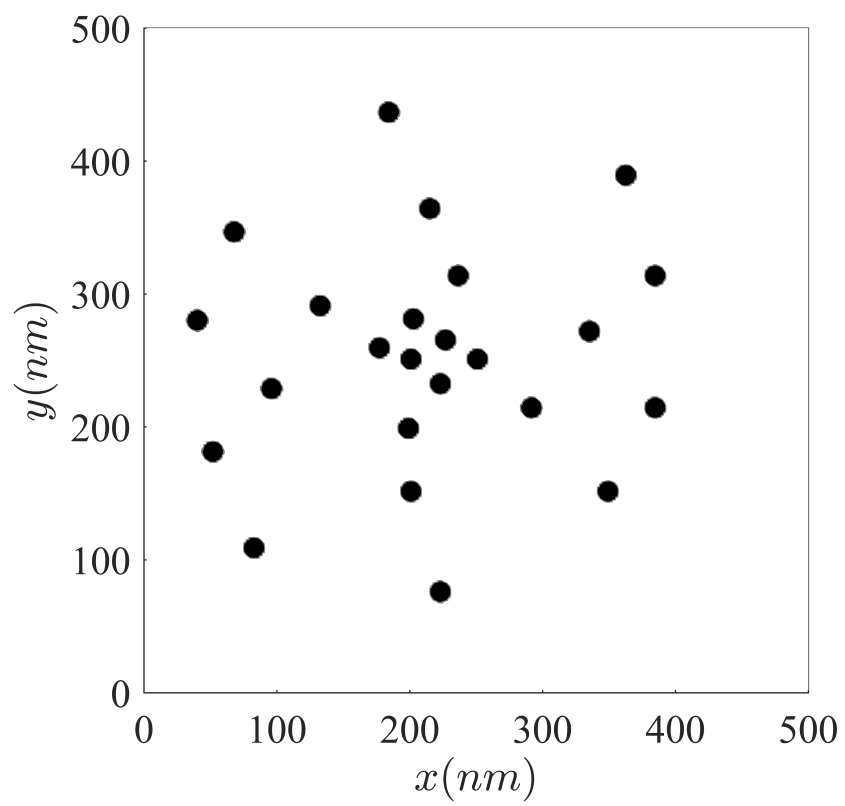


Figure 3: Test image with 15 nm fluorescent beads in a 500 nm square space

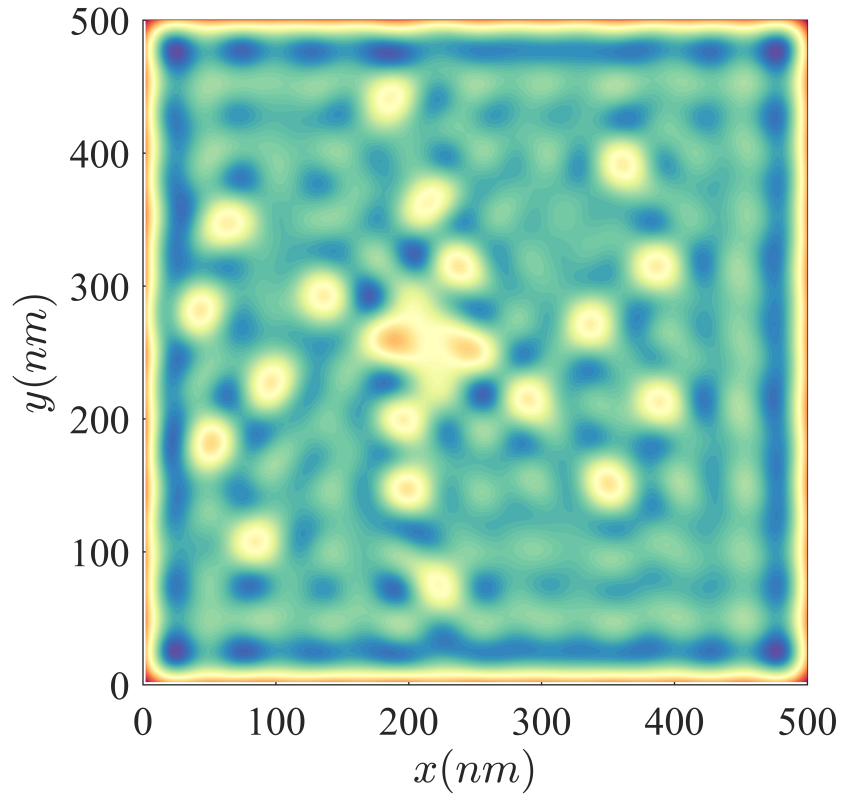


Figure 4: Simulation with GaN/AlGaN 2DEG at 20 THz corresponding to $\text{Re}(k_p) = 39k_0$

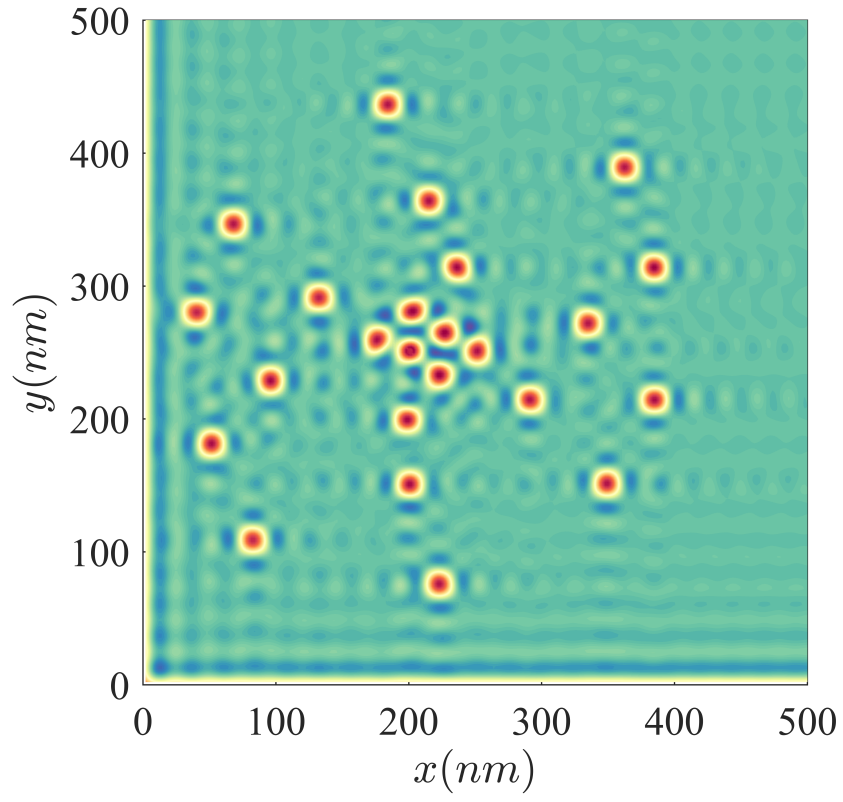


Figure 5: Simulation with GaN/AlGaN 2DEG at 25 THz corresponding to $\text{Re}(k_p) = 80k_0$

References

- [1] M. Born and E. Wolf, *Principles of Optics: Electromagnetic Theory of Propagation, Interference and Diffraction of Light*. Cambridge University Press, 1997.
- [2] M. G. L. Gustafsson, “Surpassing the lateral resolution limit by a factor of two using structured illumination microscopy,” *Journal of Microscopy*, vol. 198, pp. 82–87, may 2000.
- [3] R. Heintzmann and C. G. Cremer, “Laterally modulated excitation microscopy: improvement of resolution by using a diffraction grating,” *Proc. SPIE 3568, Optical Biopsies and Microscopic Techniques III*, vol. 3568, pp. 185–196, 1999.
- [4] M. G. L. Gustafsson, “Nonlinear structured-illumination microscopy: wide-field fluorescence imaging with theoretically unlimited resolution,” *Proceedings of the National Academy of Sciences of the United States of America*, vol. 102, pp. 13081–13086, sep 2005.
- [5] H. Nassenstein, “Superresolution by diffraction of subwaves,” oct 1970.
- [6] F. Wei and Z. Liu, “Plasmonic structured illumination microscopy,” *Nano Letters*, vol. 10, pp. 2531–2536, jul 2010.
- [7] X. Zeng, M. Al-Amri, and M. S. Zubairy, “Nanometer-scale microscopy via graphene plasmons,” *Physical Review B*, vol. 90, pp. 2–6, dec 2014.
- [8] W. F. Andress, H. Yoon, K. Y. M. Yeung, L. Qin, K. West, L. Pfeiffer, and D. Ham, “Ultra-subwavelength two-dimensional plasmonic circuits,” *Nano Letters*, vol. 12, pp. 2272–2277, may 2012.
- [9] D. C. Tsui, H. L. Stormer, and A. C. Gossard, “Two-dimensional magnetotransport in the extreme quantum limit,” *Physical Review Letters*, vol. 48, pp. 1559–1562, may 1982.
- [10] N. Reyren, S. Thiel, A. D. Caviglia, L. F. Kourkoutis, G. Hammerl, C. Richter, C. W. Schneider, T. Kopp, A.-S. Ruetschi, D. Jaccard, M. Gabay, D. A. Muller, J.-M. Triscone, and J. Mannhart, “Superconducting interfaces between insulating oxides,” *Science*, vol. 317, pp. 1196–1199, aug 2007.

- [11] M. Dyakonov and M. Shur, “Shallow water analogy for a ballistic field effect transistor: New mechanism of plasma wave generation by dc current,” *Physical Review Letters*, vol. 71, pp. 2465–2468, oct 1993.
- [12] M. Dyakonov and M. Shur, “Detection, mixing, and frequency multiplication of terahertz radiation by two-dimensional electronic fluid,” *IEEE Transactions on Electron Devices*, vol. 43, pp. 380–387, mar 1996.
- [13] V. V. Popov, G. M. Tsymbalov, and M. S. Shur, “Plasma wave instability and amplification of terahertz radiation in field-effect-transistor arrays,” *Journal of Physics: Condensed Matter*, vol. 20, p. 384208, aug 2008.
- [14] T. Otsuji, M. Hanabe, T. Nishimura, and E. Sano, “A grating-bicoupled plasma-wave photomixer with resonant-cavity enhanced structure,” *Optics Express*, vol. 14, p. 4815, may 2006.
- [15] A. V. Muravjov, D. B. Veksler, V. V. Popov, O. V. Polischuk, N. Pala, X. Hu, R. Gaska, H. Saxena, R. E. Peale, and M. S. Shur, “Temperature dependence of plasmonic terahertz absorption in grating-gate gallium-nitride transistor structures,” *Applied Physics Letters*, vol. 96, p. 042105, jan 2010.
- [16] P. J. Burke, I. B. Spielman, J. P. Eisenstein, L. N. Pfeiffer, and K. W. West, “High frequency conductivity of the high-mobility two-dimensional electron gas,” *Applied Physics Letters*, vol. 76, pp. 745–747, feb 2000.
- [17] M. Nakayama, “Theory of surface waves coupled to surface carriers,” *Journal of the Physical Society of Japan*, vol. 36, pp. 393–398, feb 1974.
- [18] M. Jablan, H. Buljan, and M. M. Soljacić, “Plasmonics in graphene at infrared frequencies,” *Physical Review B*, vol. 80, dec 2009.
- [19] A. Jost and R. Heintzmann, “Superresolution multidimensional imaging with structured illumination microscopy,” *Annual Review of Materials Research*, vol. 43, pp. 261–282, jul 2013.